

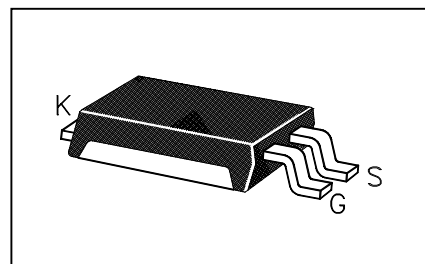
Features

- POWERMITE 3 Surface Mount Package
- MOSFET with Schottky Rectifier for reverse voltage blocking
- Single 3 leaded device replaces 2 individual components
- Integral Heat Sink / Locking Tabs
- Supplied in 16mm Tape and Reel – 6000 units/reel
- Superior Low Thermal and Electrical capability

SURFACE MOUNT P – CHANNEL MOSKEY®

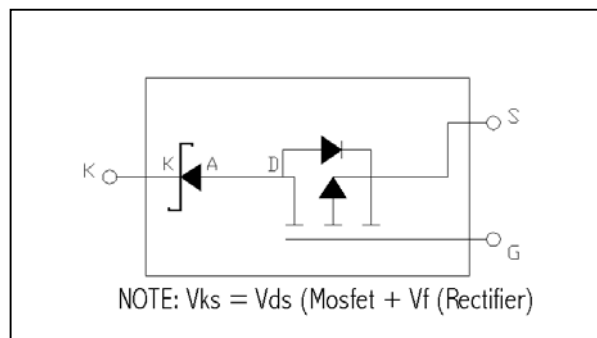
Mechanical Characteristics

- Footprint Area of 16.51 mm²
- Case: Molded Epoxy
- Meets UL94VO at 1/8 inch
- Weight: 72 milligrams
- Lead and Mounting Temperatures: 260°C max for 10 seconds



Description

The MOSKEY® combines a MOSFET with a Schottky Rectifier to provide reverse blocking capability in a single three leaded package. This device is well suited for applications such as battery chargers and switching where the intrinsic source-drain diode is an undesirable feature.



Absolute Maximum Ratings at 25°C

| RATING | SYMBOL | VALUE | UNIT |
|---------------------------|--------|--------------|-------|
| Cathode-to-Source Voltage | VKSS | +/- 20 | Vdc |
| Gate-to-Source Voltage | VGS | +/- 10 | Vdc |
| Cathode Current: | | | |
| Continuous @ TA=25°C | IK | 1.0 | Adc |
| Single Pulsed | IKM | 6.0 | Apk |
| Total Power Dissipation | PD (1) | 1.9 | Watts |
| Storage Temperature | T stg | -55 to 150°C | °C |
| Operating Temperature | T op | -55 to 150°C | °C |

Thermal Characteristics

Thermal Resistance:

| | | | |
|-------------------------|---------|-----|---------|
| Junction to Tab | Rjtab | 20 | °C/Watt |
| (1) Junction-to-ambient | Rja (1) | 65 | °C/Watt |
| (2) Junction-to-ambient | Rja (2) | 150 | °C/Watt |

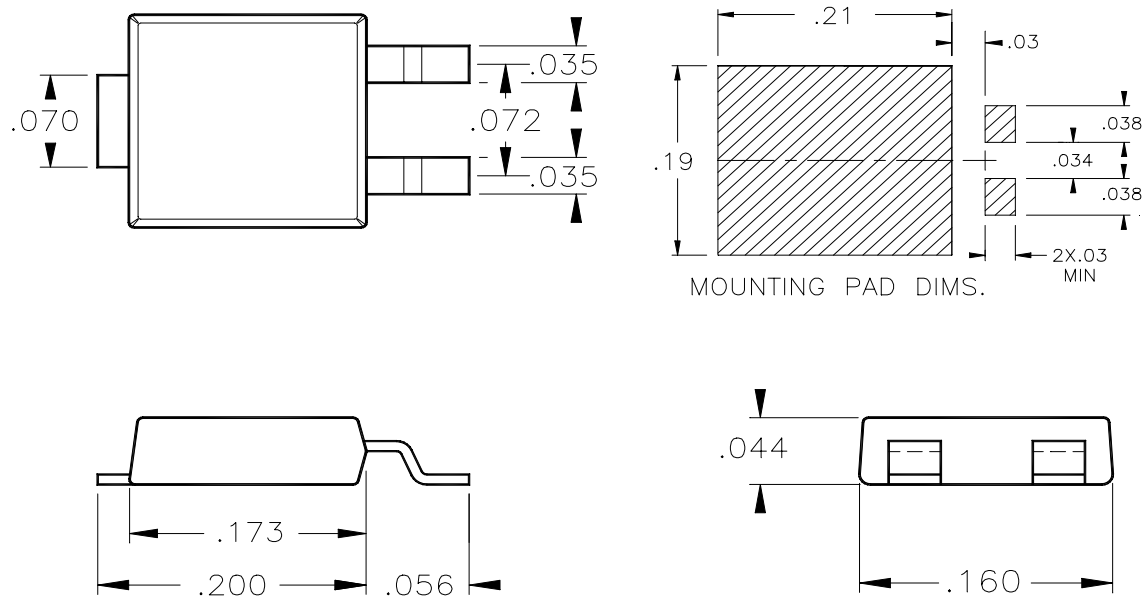
- (1) Mounted on 2" square by 0.06" thick FR4 board with a 1" x1" square 2 ounce copper pattern.
(2) Mounted on 0.06 thick FR4 board, using recommended footprint.

PRELIMINARY

Electrical Characteristics at 25°C

| ELECTRICAL CHARACTERISTICS (TA = 25°C unless otherwise noted) | | | | | | |
|--|--|---|-----|-----|-----|-------|
| Symbol | Parameter | Conditions | Min | Typ | Max | Units |
| OFF CHARACTERISTICS | | | | | | |
| BVKSS | Cathode-Source Breakdown Voltage | VGS = 0V; IK = 250uA | 20 | | | V |
| IKSSF | Zero Gate Voltage Cathode Current: Forward | VKS = -16V, VGS = 0V | | | 1 | uA |
| IKSSR | Zero Gate Voltage Cathode Current: Reverse | VKS = +16V, VGS = 0V | | | 1 | mA |
| IGSS | Gate-Body Leakage Current | VGS = +/- 8V, VKS = 0V | | | 100 | nA |
| ON CHARACTERISTICS (pulsed 500us max, duty cycle < 2%) | | | | | | |
| VGS(TH) | Gate Threshold Voltage | VKS ≥ VGS; IK = 250uA | 1 | 1.9 | 3 | V |
| DELTA VGS(TH)/TJ | Gate Threshold Voltage Temp Coefficient | IK = 250uA, Reference to 25°C | | 3.5 | | mV/°C |
| VKS (ON) | Static Cathode-Source On Voltage | VGS = 4.5 V; IK = 1A | | | 750 | mV |
| VKS (ON) | Static Cathode-Source On Voltage | VGS = 4.5 ; IK = 0.5A | | | 550 | mV |
| IK(ON) | On State Cathode Current | VGS = 4.5 V; VKS = 5V | 3 | | | A |
| Gfs | Forward Transconductance | VDS = 5V; IK = 0.5A | | 3 | | S |
| DYNAMIC CHARACTERISTICS | | | | | | |
| Ciss | Input Capacitance | VKS = 15 V; VGS = 0V, F = 1MHz | | 165 | | pF |
| Coss | Output Capacitance | VKS = 15 V; VGS = 0V, F = 1MHz | | 60 | | pF |
| Crss | Reverse Transfer Capacitance | VKS = 15 V; VGS = 0V, F = 1MHz | | 25 | | pF |
| SWITCHING CHARACTERISTICS | | | | | | |
| Td(ON) | Turn On Delay Time | VDD = 15V, IK = 1A, VGS = 10V, Rg = 6 Ω | | 8 | 20 | ns |
| Tr | Turn On Rise Time | VDD = 15V, IK = 1A, VGS = 10V, Rg = 6 Ω | | 9 | 20 | ns |
| Td(OFF) | Turn Off Delay time | VDD = 15V, IK = 1A, VGS = 10V, Rg = 6 Ω | | 14 | 30 | ns |
| Tf | Turn Off Fall time | VDD = 15V, IK = 1A, VGS = 10V, Rg = 6 Ω | | 2 | 10 | ns |
| Qg | Total Gate Charge | VDS = 15V, IK = 1A, VGS = 10V | | 3.5 | 5 | nC |
| Qgs | Gate-Source Charge | VDS = 15V, IK = 1A, VGS = 10V | | 0.6 | | nC |
| Qgd | Gate-Cathode Charge | VDS = 15V, IK = 1A, VGS = 10V | | 0.8 | | nC |

PRELIMINARY



DIMENSIONS ARE NOMINAL INCHES

MECHANICAL SPECIFICATIONS